

A High-Granularity Timing Detector for the Phase-II upgrade of the ATLAS detector

- detector concept, description and R&D and beam test results

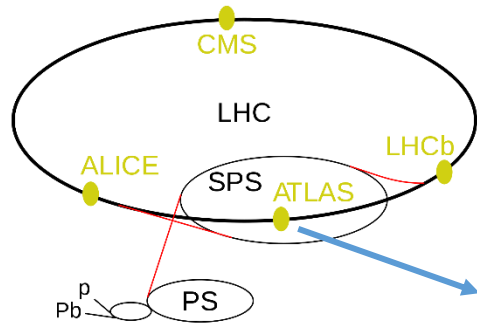
Yusheng Wu

University of Science and Technology of China

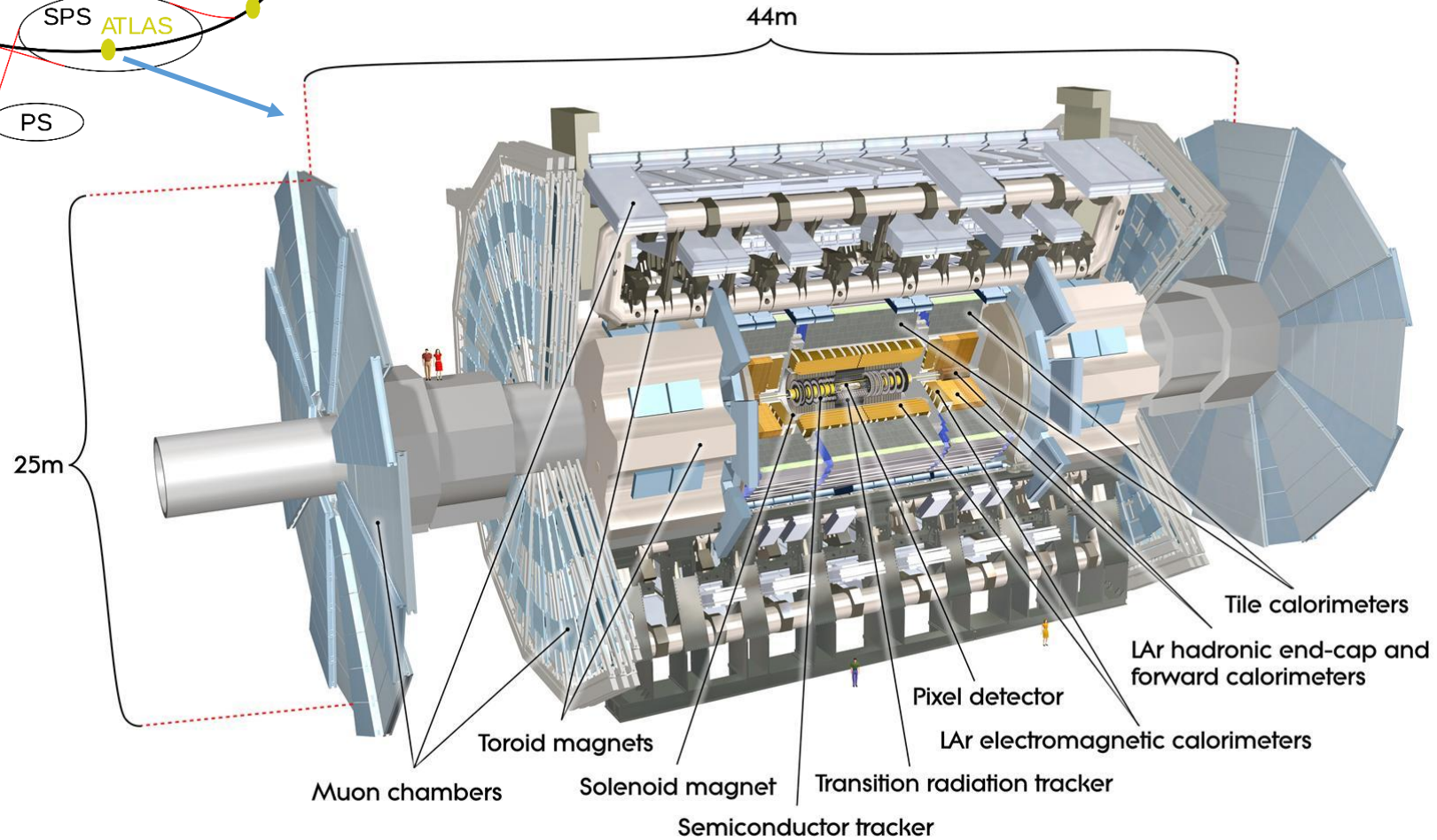
For ATLAS HGTD Project

2020 IEEE NSS and MIC, Oct 31 to Nov 7

ATLAS Detector

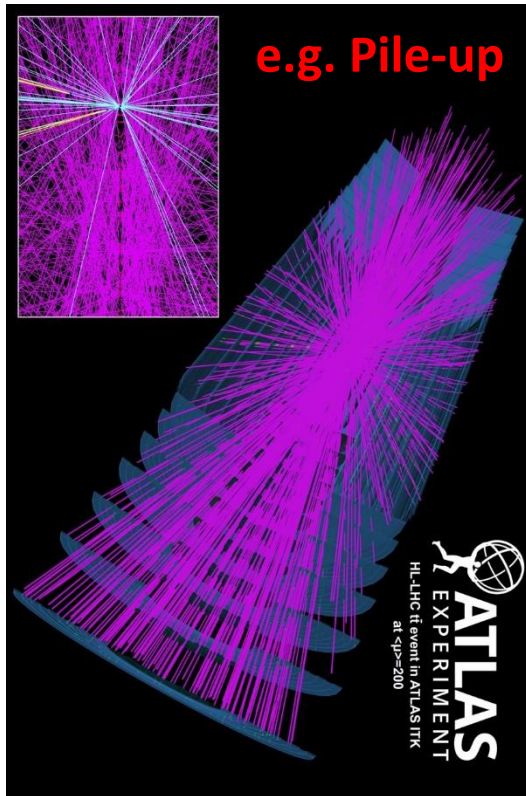


Designed for a thorough investigation of **Higgs boson** physics and **new physics** at TeV scale



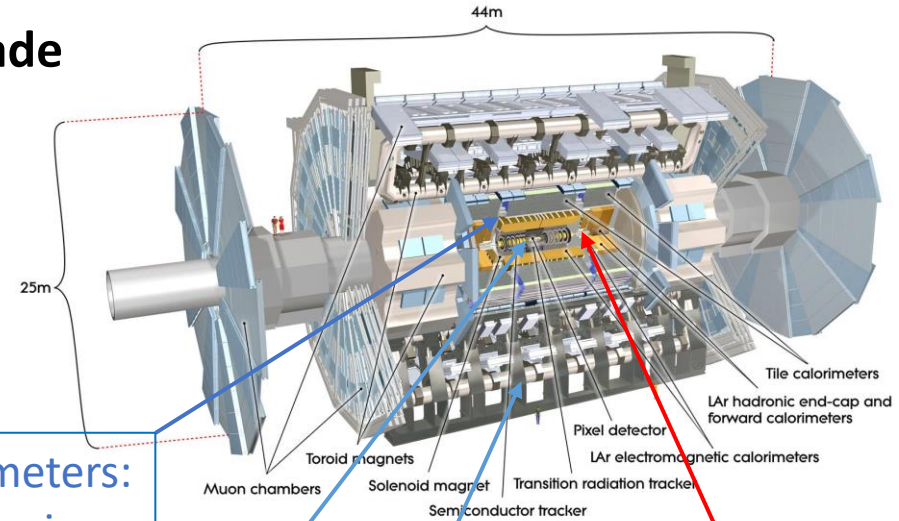
Future: HL-LHC up to 3ab^{-1} 14 TeV pp collisions

Unprecedented opportunities,
Unprecedented challenges



11/02/2020

Phase-II Upgrade
(2025 – 2027)
Sustainability
Improvement
Novelty



LAr, Tile Calorimeters:
Readout electronics

New Inner Detector (ITk):
Full silicon detectors

TDAQ System:
Trigger and DAQ Upgrade

Muon system:
Readout electronics;
partial upgrade of
precision and
trigger chambers

High Granularity Timing Detector (HGTD):
Track timing in forward region
([ATLAS-TDR-031](#))

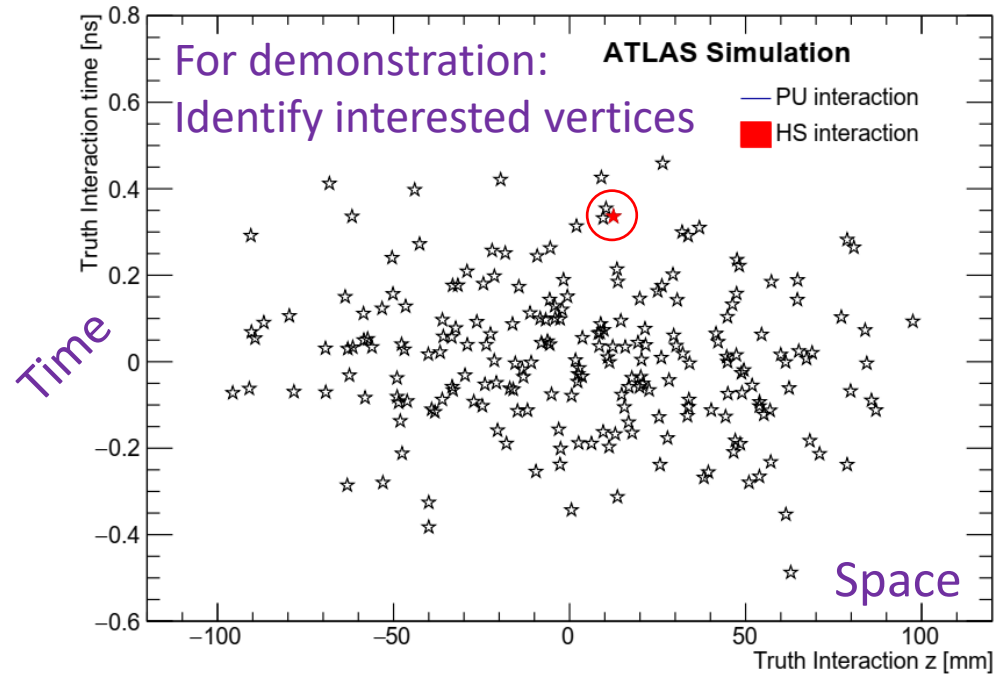
[More info.](#)

Y. Wu

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Motivation for HGTD

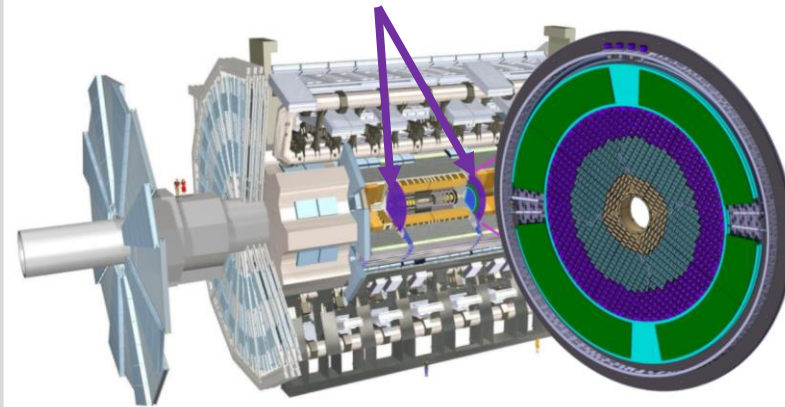
Precise timing $O(10)$ ps will introduce a new dimension for physics at ATLAS



- Improve on the pileup suppression
- Would enhance lifetime/pID measurement

See also relevant discussion in [CMS Timing Detector](#)

Minimum-bias scintillator ending service then → **Opportunity to install a novel detector**



- **Forward region only** (no plans nor resources for a full coverage)
- **Tight spatial constraints**
- Radiation hardness and $O(10)$ ps timing requires → **advanced detector technologies**
- Also a **luminosity detector**

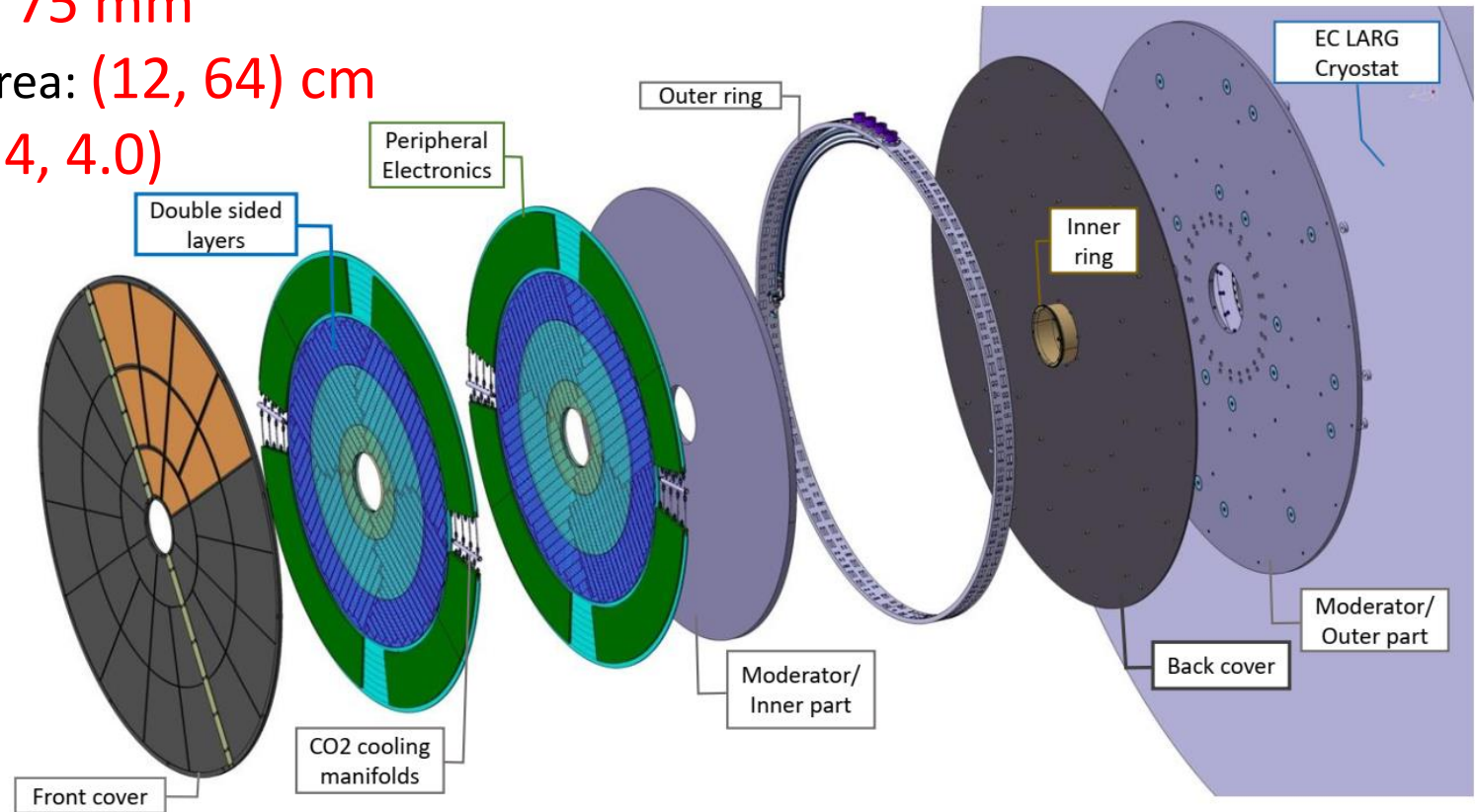
HGTD in a nutshell

Overall thickness: **75 mm**

Radial sensitive area: **(12, 64) cm**

$|\eta|$ coverage: **(2.4, 4.0)**

2 double-sided layers,
4 measurement planes



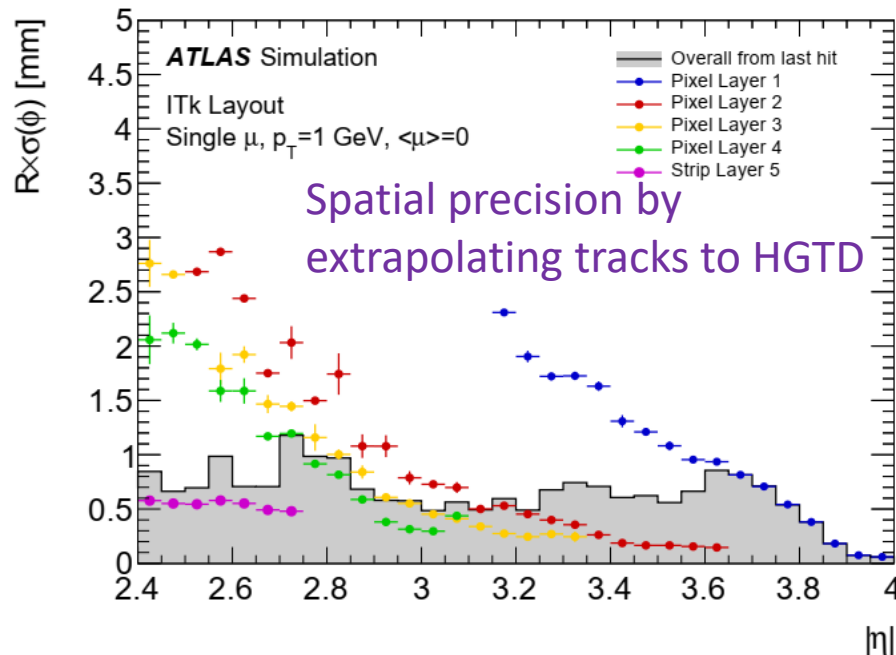
> 3600000 Low Gain Avalanche Detector (**LGAD**) units, each **1.3 mm x 1.3 mm x 50 μm** (active), grouping into **> 8000 modules**, containing **> 16000 ASIC FEBs**

Time resolution:
per-hit **35 – 70 ps**
per-track **30 – 50 ps**
Radiation-level dependent

About O(1) mm and O(10) ps

1.3 mm – unit sensor size

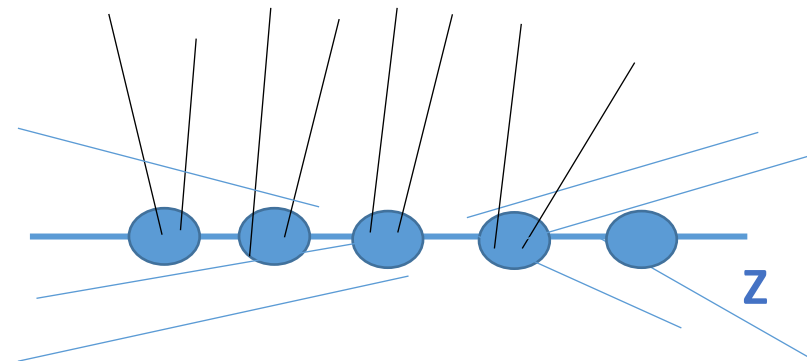
- About the spatial precision of track extrapolation from silicon trackers
- Balanced also between occupancy, double hits, dead areas, capacitance, and increasing channel numbers



35-70 ps per hit

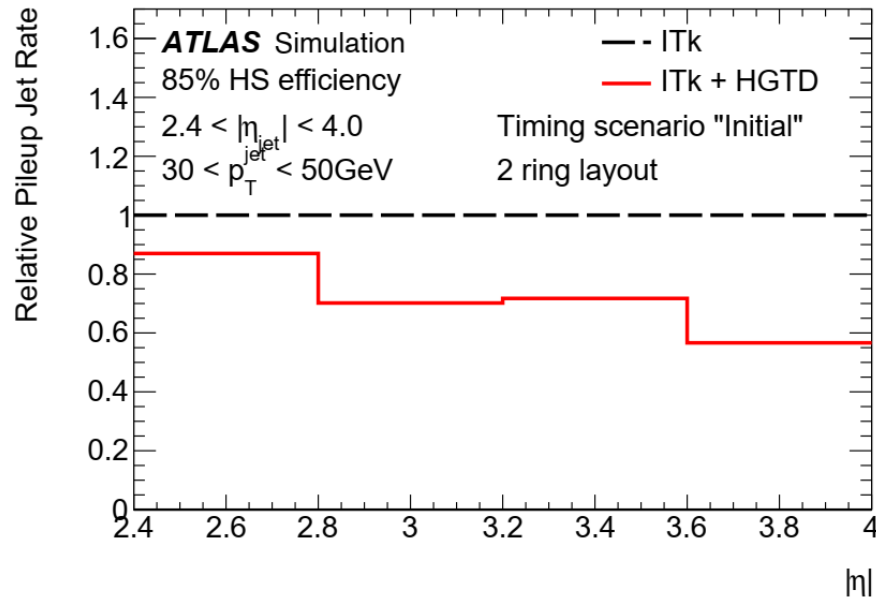
- Already cutting-edge specification
- bottom line: per-hit time resolution $\lesssim 100$ ps to guarantee effectiveness in physics case

Complexity of tracks v.s. vertices, especially in forward region, worsen z_0 resolution

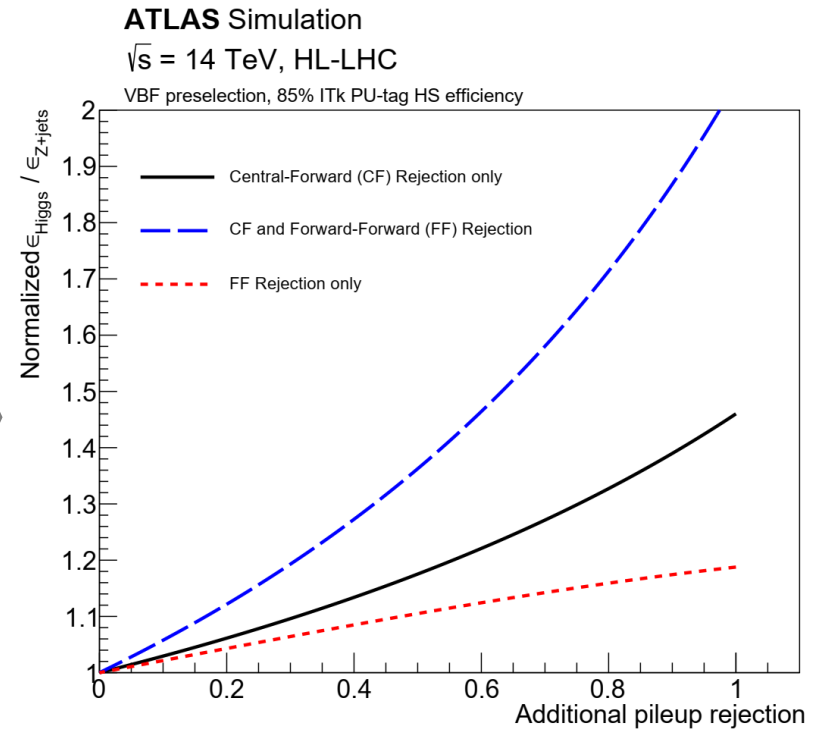


Timing the tracks (blue) can help to solve the mystery

Demonstration of Physics Potentials



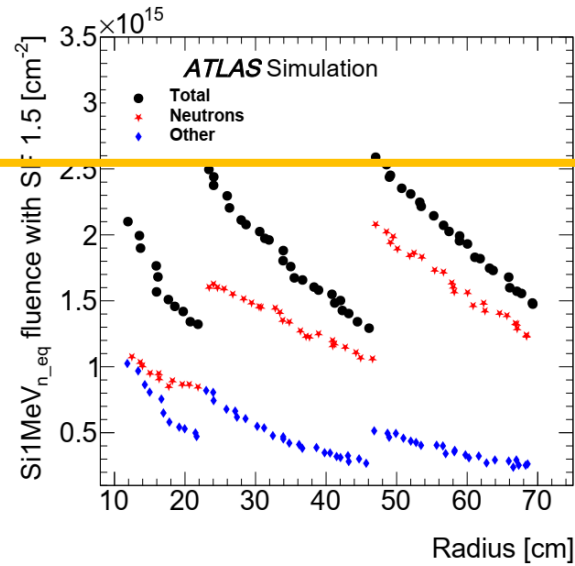
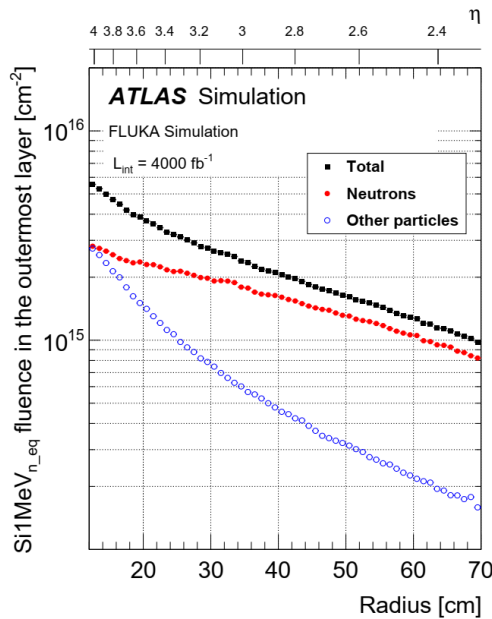
Up to 2 x more power to further suppress pileup contributions in the forward region, on top of the planned full silicon detector



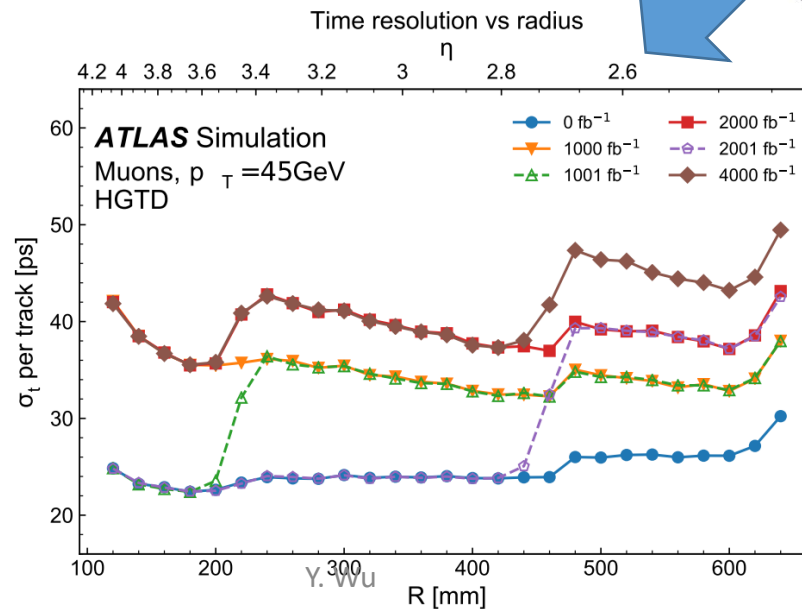
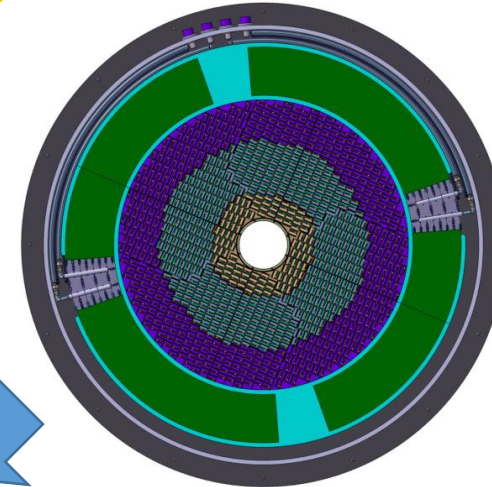
For analyses subject to pileup backgrounds (e.g. VBF $H \rightarrow$ invisible), sizable improvement of S/N with help of HGTD

Three-ring and Replacement

Suffers from **high radiation** (forward) => worsen performance



Replace inner and middle rings along data taking to keep total dose within safety

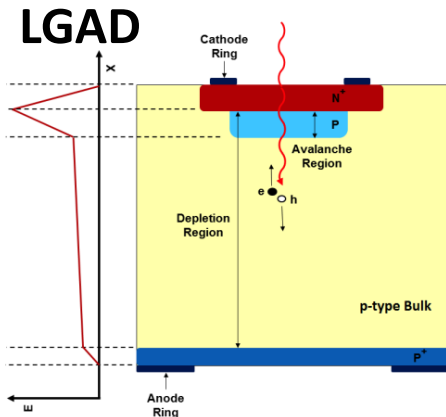


Expected stabilized performance (shown for track σ_t)

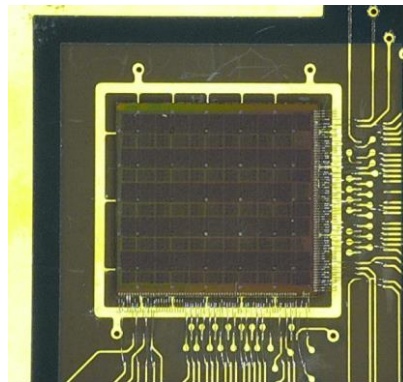
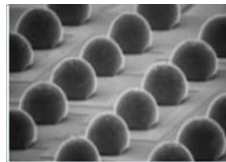
Timing Measurement

* unirradiated case

** with timewalk correction expected

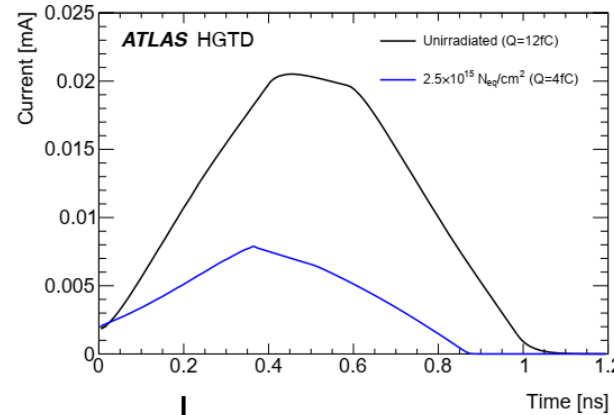


Bump-bonding

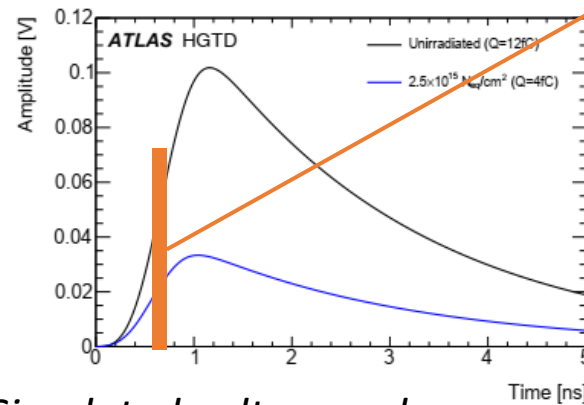


Customized ASIC (ALTIROC)

Simulated current pulse



After preamplification



Simulated voltage pulse

Time of arrival

→ time measurement

Resolution factors:

Sensor:

Landau effects $\lesssim 25$ ps* → non-uniform e-h generation pattern

$$\sigma_{\text{total}}^2 = \sigma_{\text{L}}^2 + \sigma_{\text{elec}}^2 + \sigma_{\text{clock}}^2$$

Electronics / DAQ:

electronic noise (jitter), and amplitude variation (timewalk**) $\lesssim 25$ ps; clock distribution $\lesssim 15$ ps

LGAD Design

* Pioneered by CNM, Barcelona; further developed with CERN RD50 collaboration

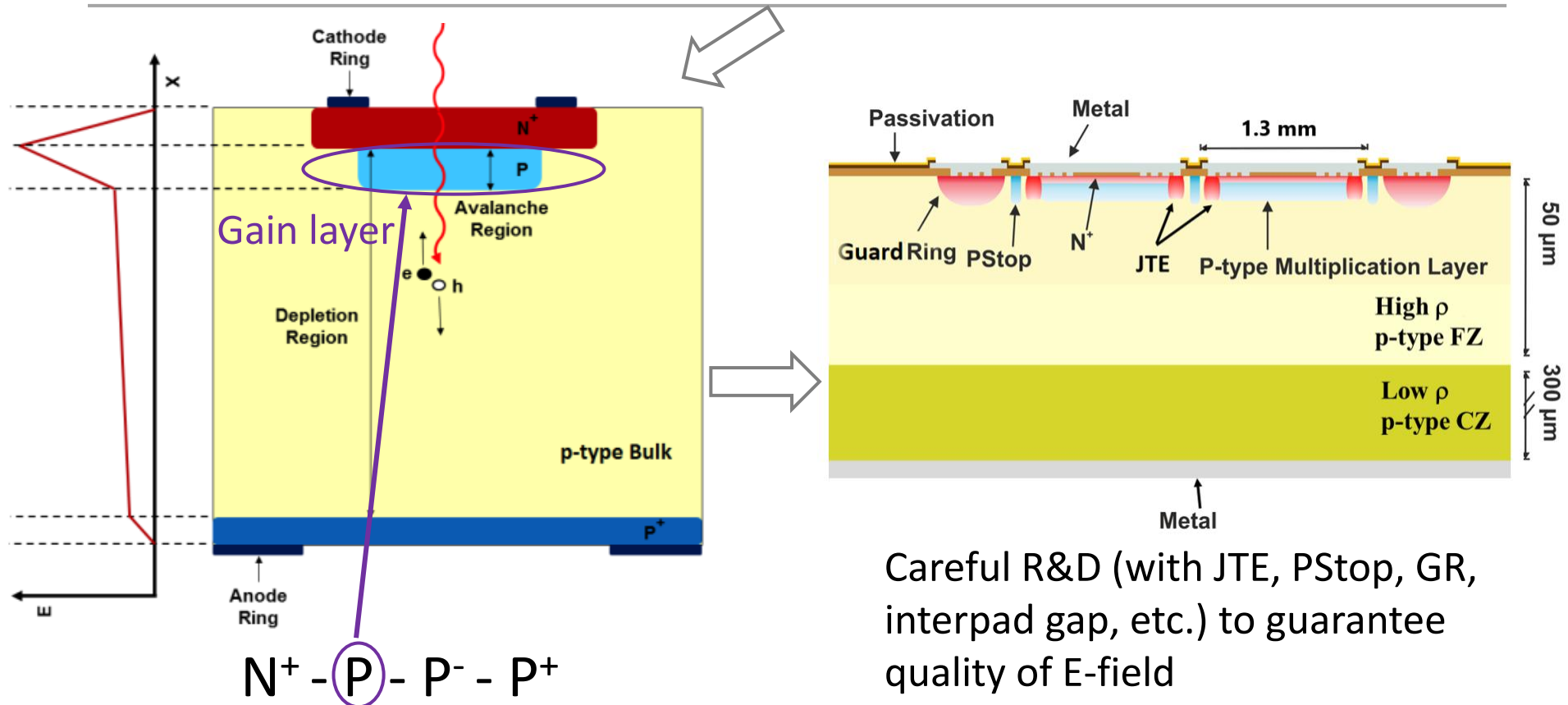
Silicon detector has good virtues for this application (radiation-hard, granularity, mature tech., ...)

Keys* to achieve desired resolution

Thin: 50 μm

Gain: x20 (\rightarrow 10 fC)

\Rightarrow Larger dV/dt
 \Rightarrow Larger S/N
 \Rightarrow Less Landau non-uniformity



Sensor Performance

Sensor R&D involves multiple manufacturers (varying gain doping etc.)

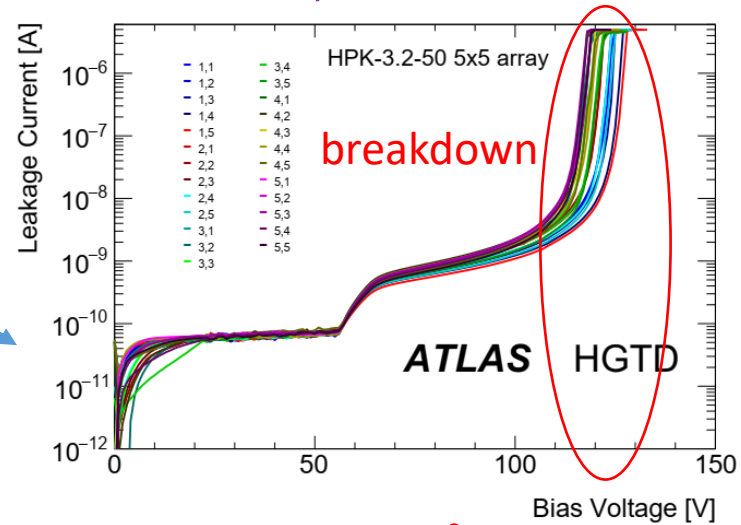
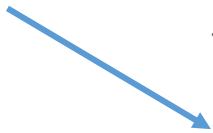


Electrical measurement (I-V, C-V)
Laser or radioactive source, Test beam

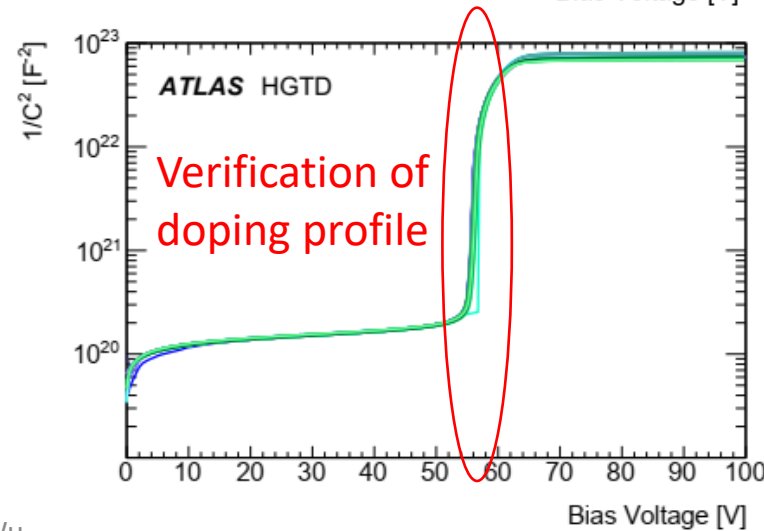
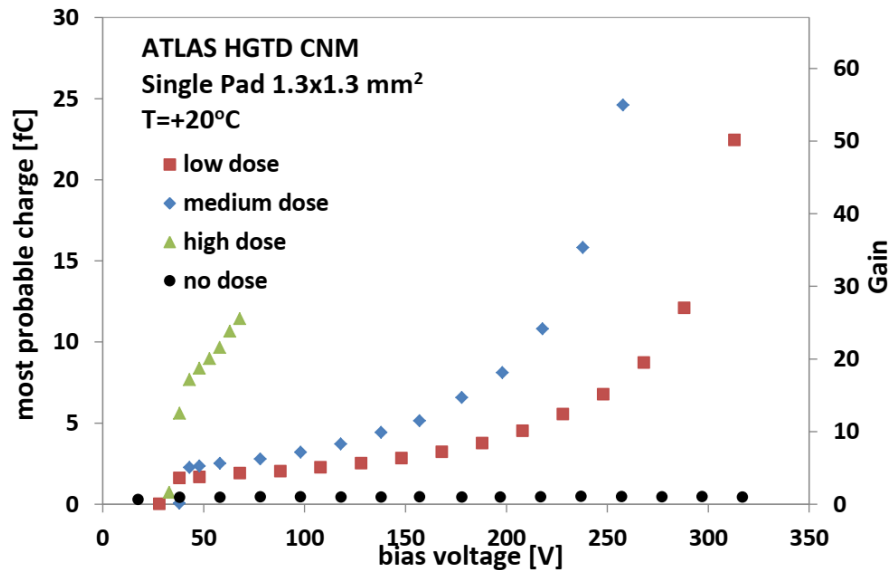
Promising performance shown (unirradiated sensors)



Effectiveness of doping gain layer



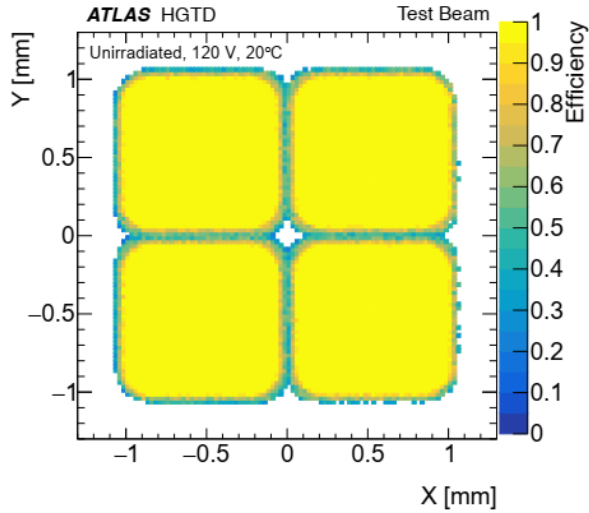
I-V



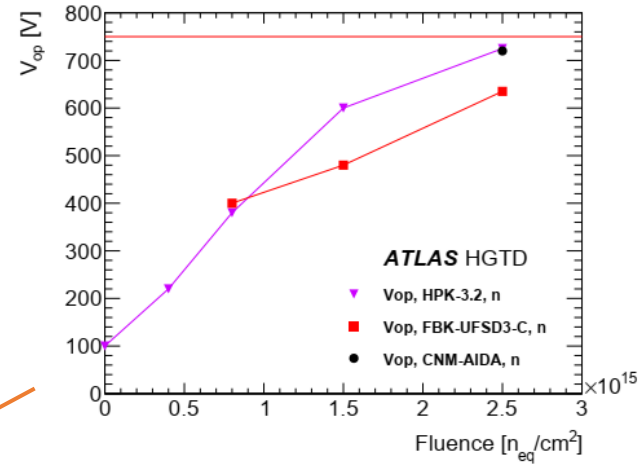
C-V

Sensor Performance

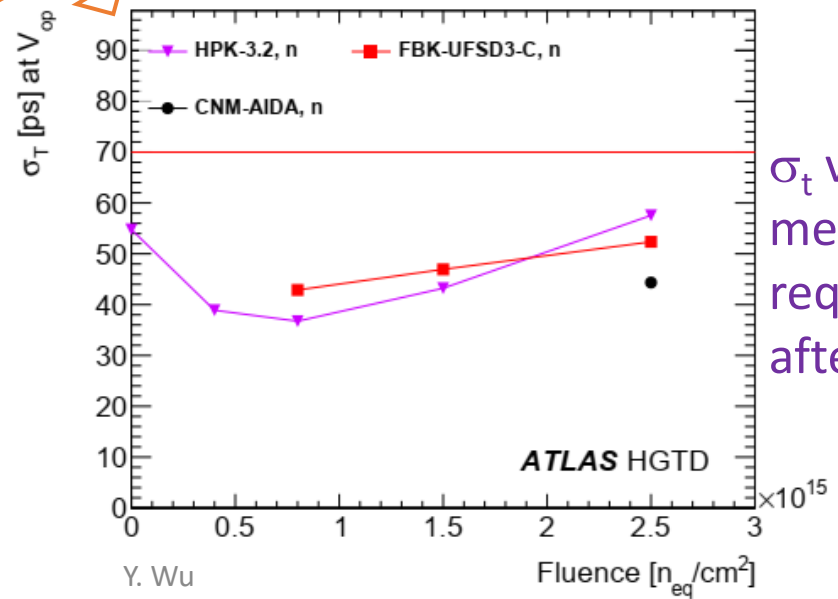
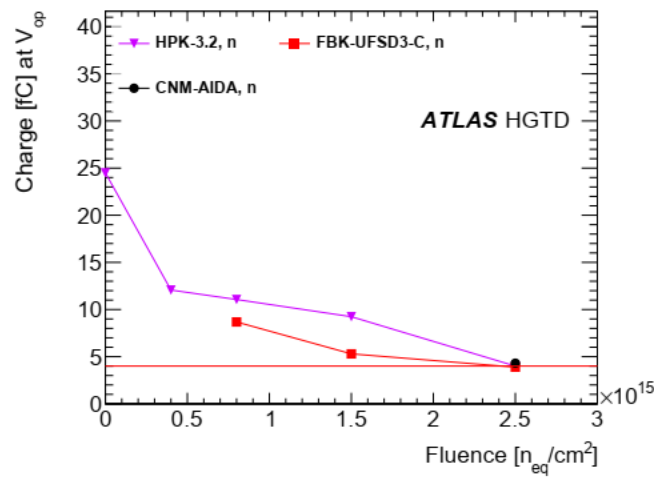
Test beam verified high hit efficiency



Operation voltage v.s. fluence: 100 → 700 V



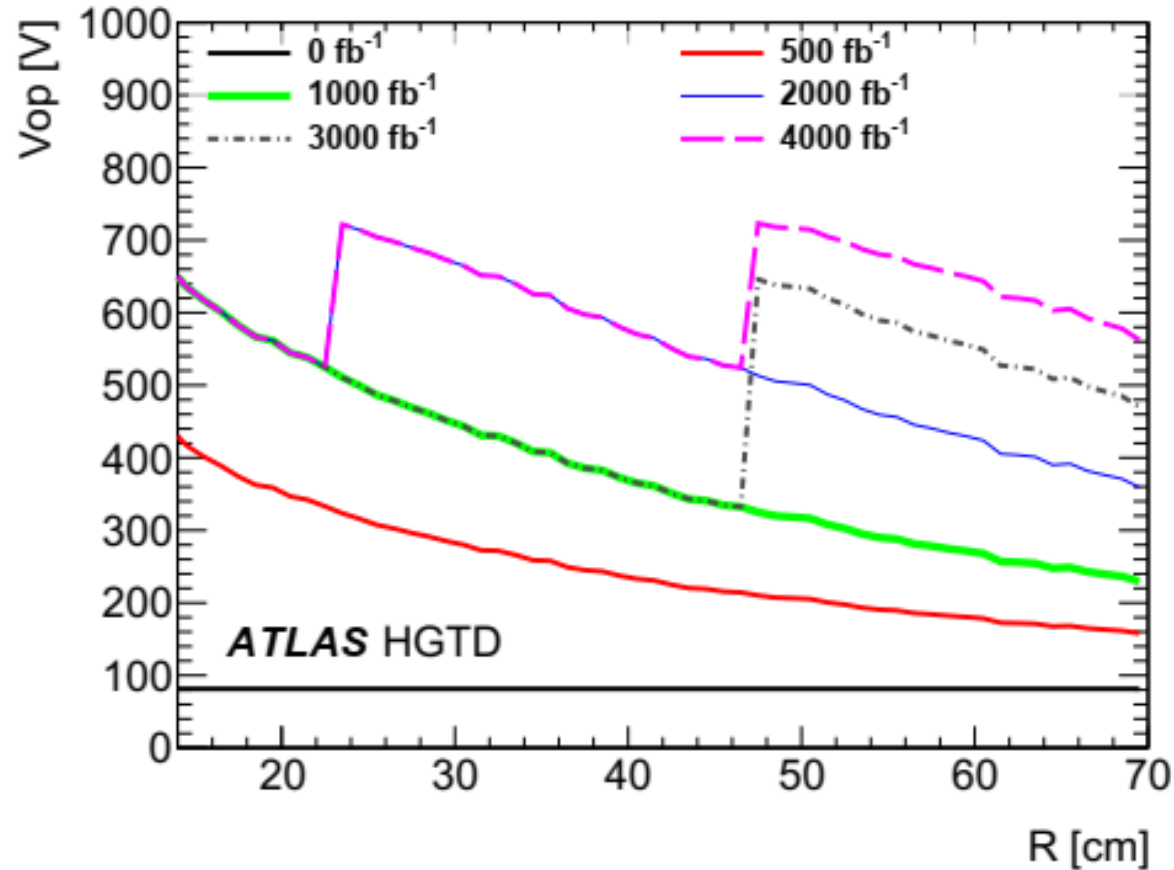
Charge collection v.s. fluence



σ_t v.s. fluence:
meet the
requirement
after irradiation

Operation and Plan

Planned operation voltage for LGAD v.s. lumi / R



LGAD manufacturing
shown to meet
detector specification

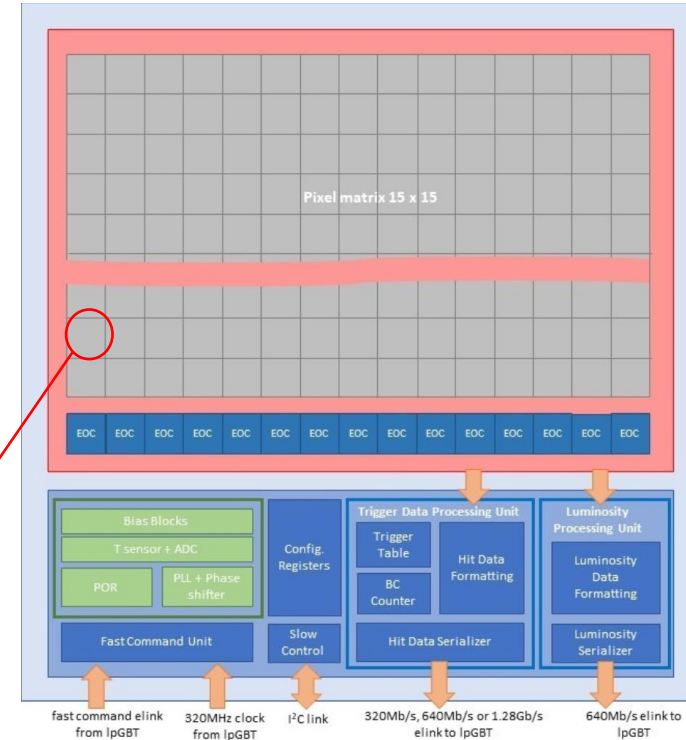
Further optimization
ongoing ...

Front-end Electronics

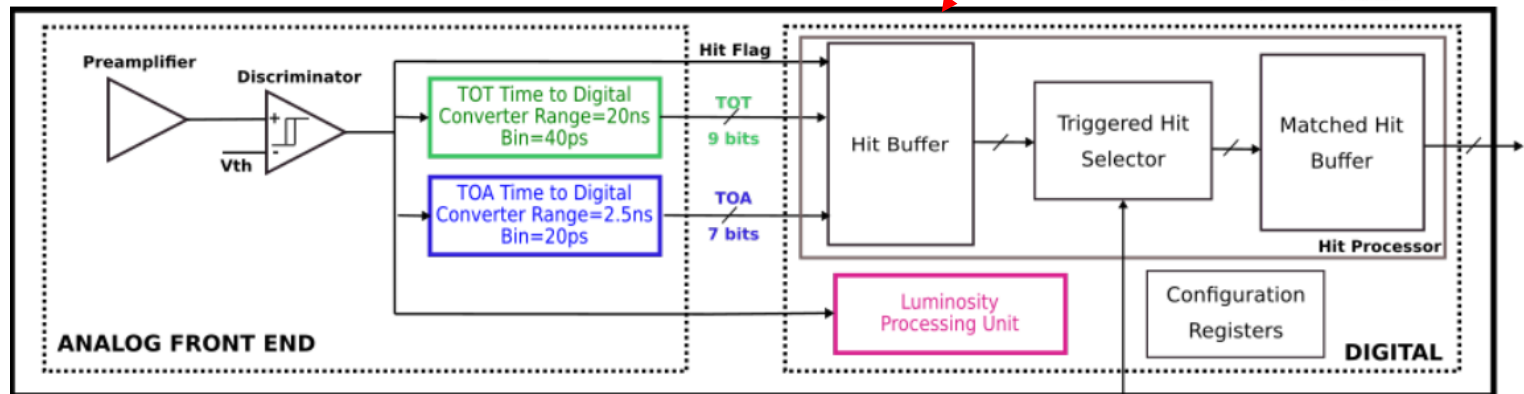
ALTIROC Key characteristics:

- Radiation hardness
- Noise ≤ 0.5 fC
- Dynamic range: 4-50 fC
- Low min-threshold: 2 fC
- Cross-talk $< 5\%$
- Jitter, time-walk, TDC $O(10)$ ps
- e-link driver bandwidth up to 1.28 Gbit/s

ASIC chip schematic

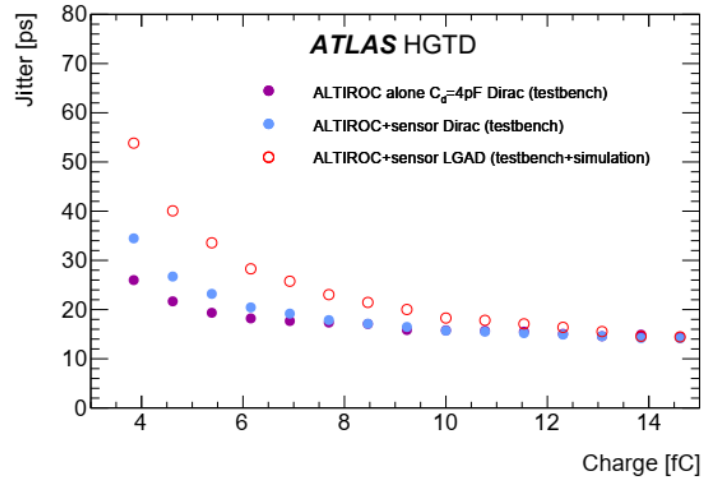


Single channel schematic

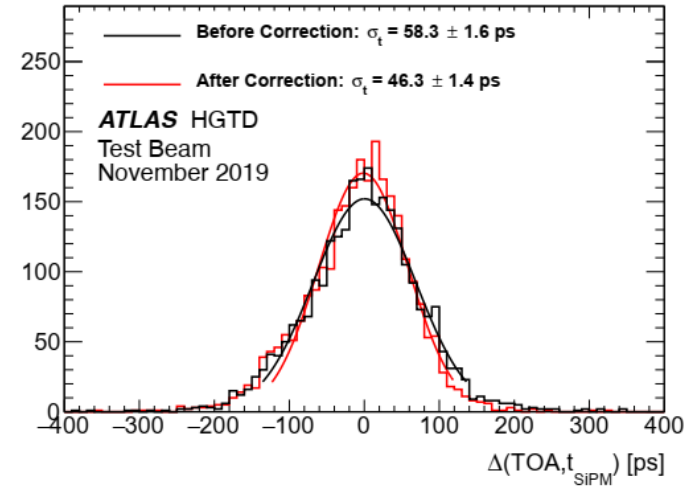


FEE performance

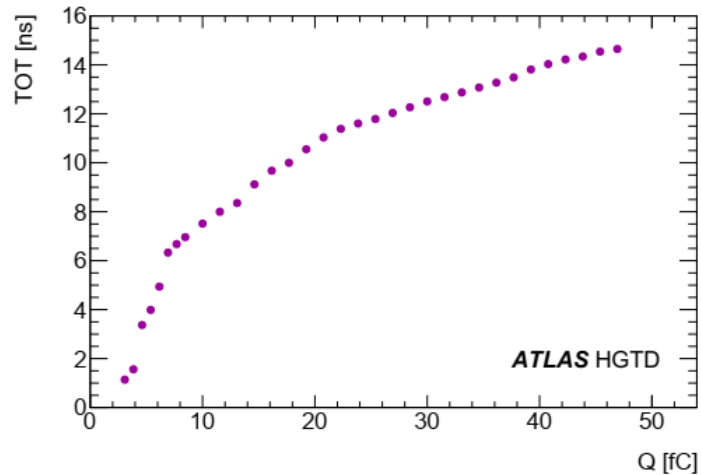
Jitter Estimation: meet the goal



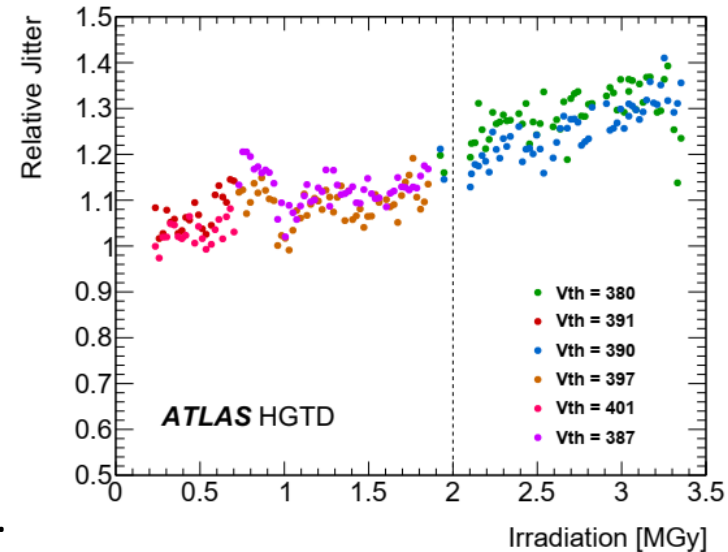
Test-beam LGAD+ALTIROC time resolution



TOT vs Q: used for time-walk correction



Stability of jitter v.s. irradiation

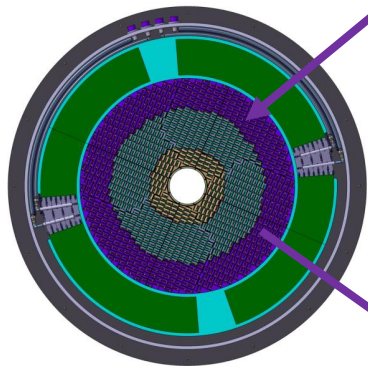


Iteration and completion of ALTIROC ongoing...

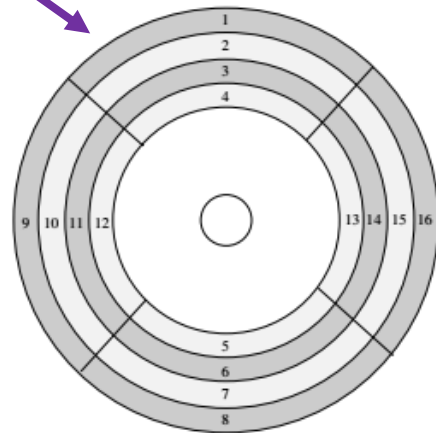
Luminosity Measurement

Precise knowledge of luminosity is a key to many physics studies

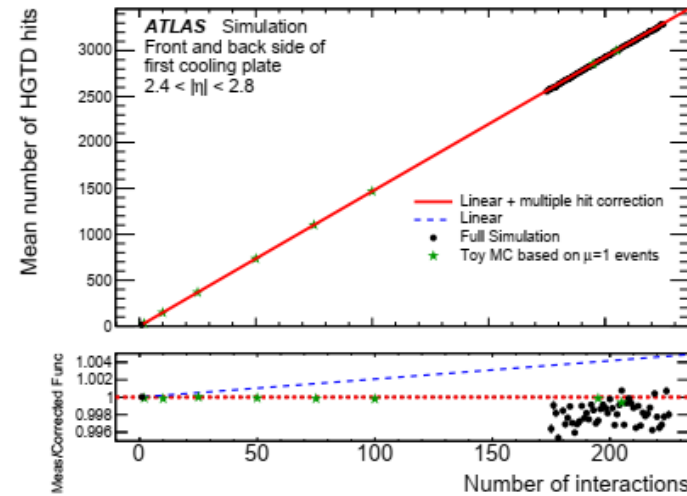
HGTD provides precise bunch-by-bunch luminosity measurement in its outmost ring



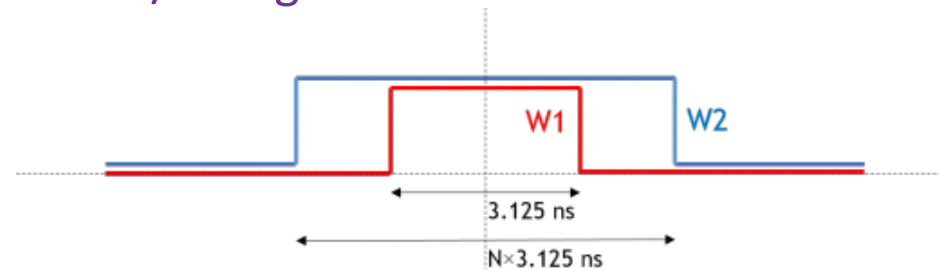
Planned for 16 partitions with independent measurements



High granularity \rightarrow great linearity between measurements and luminosity

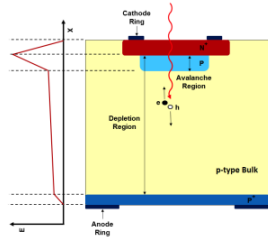


Unique two timing window scheme at ASIC level give in-situ measurement of noise/afterglow

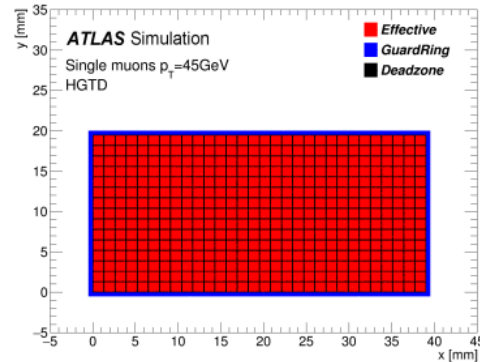


The Flow

Single LGAD Pad

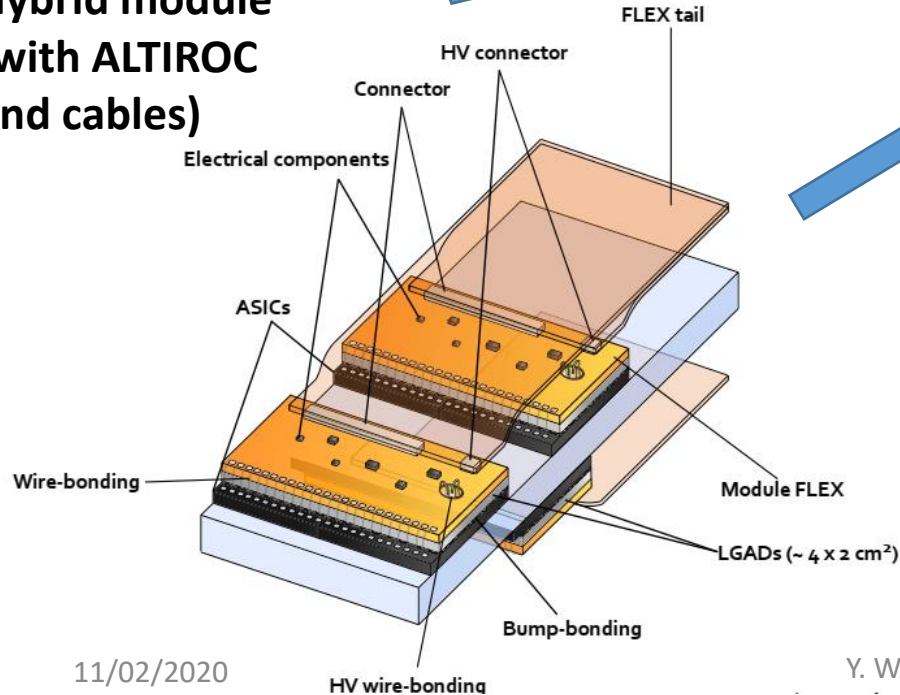


15 x 30 LGAD module

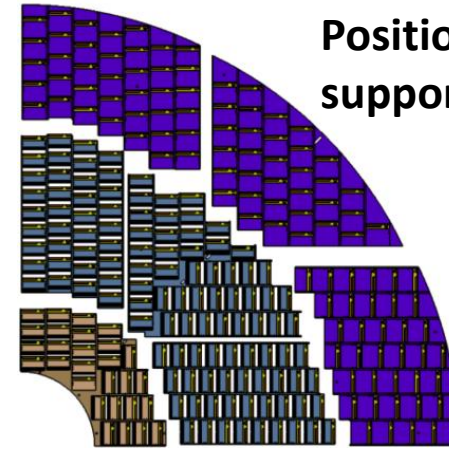


Fill factor $\sim 90\%$

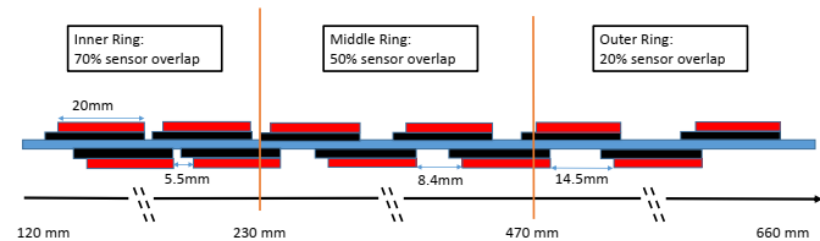
Hybrid module (with ALTIROC and cables)



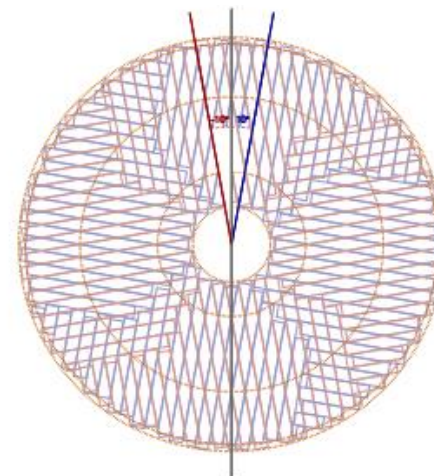
Position modules on support structure



Front/Back Overlay per layer



Layer 1 and 2: small inclination angle



Summary

HGTD will be a novel subdetector in ATLAS for HL-LHC, providing precise timing measurement capabilities and unique luminosity measurement, to host in a very narrow space

Adapt novel detector technologies (LGAD) and require high-standard ASIC, both been carefully R&D-ed and found promising

Technical Design Report ([ATLAS-TDR-031](#)) recently approved by CERN, R&D / prototyping / production continues in next years, to be install in 2026-2027

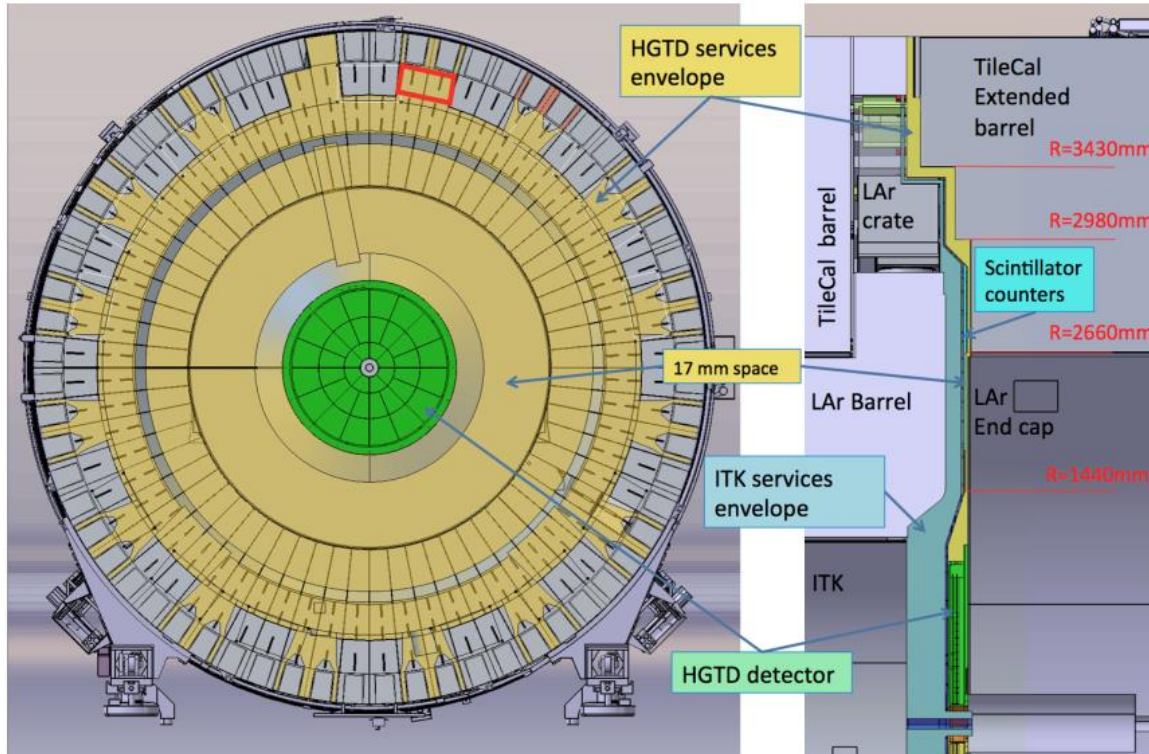
Although forward only, potential of physics capabilities shall not be underestimated and is being pursued



Thank you for your attention!

Backup

More



Cooling and services with a very tight space budget

=> Careful R&D has been conducted

